

REMARKS

This is in response to the Office Action dated August 30, 2006. Claims 1-13 are currently pending.

Claim 1 stands rejected under 35 U.S.C. Section 102(b) as being allegedly anticipated by Lien. This Section 102(b) rejection is respectfully traversed.

Claim 1 requires that “*at least one of said other wirings of said second wiring layer that is insulated from said bonding pad is electrically connected to the first wiring layer by way of a via defined in an insulator located between said first and second wirings layers.*” For example and without limitation, Fig. 6 of the instant application illustrates that at least one of the other wirings 12 of the second wiring layer that is insulated from bonding pad 1 is electrically connected to the first wiring layer 17 by way of a via 21 defined in an insulator 18 located between said first and second wirings layers. The cited art fails to disclose or suggest the aforesaid quoted feature of claim 1.

Lien fails to disclose or suggest the aforesaid quoted feature of claim 1. In particular, Lien fails to disclose or suggest that a wiring of the alleged second wiring layer that is insulated from said bonding pad is electrically connected to the first wiring layer by way of a via defined in an insulator located between said first and second wirings layers as required by claim 1. In Fig. 6 of Lien, the only wiring of the second wiring layer 311 that is connected to the first layer 210 is also electrically connected to the bonding pad 316 (not insulated from the pad), thereby teaching directly away from the invention of amended claim 1. Thus, not only does Lien fail to disclose the invention of claim 1, but Lien teaches directly away from the same.

Claims 7 and 11 also requires that “at least one of said other wirings of said second wiring layer that is insulated from said bonding pad is electrically connected to the first wiring

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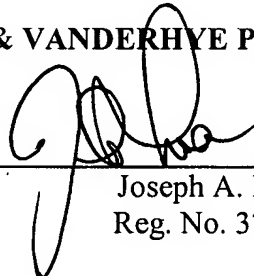
layer by way of a via defined in an insulator located between said first and second wirings layers." Again, Lien fails to disclose or suggest this feature of claims 7 and 11. Moreover, citation to other art cannot cure the aforesaid fundamental flaw of Lien.

It is respectfully requested that all rejections be withdrawn. All claims are in condition for allowance. If any minor matter remains to be resolved, the Examiner is invited to telephone the undersigned with regard to the same.

Respectfully submitted,

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